

Single P-channel MOSFET

ELM13421CA-S

General description

ELM13421CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

Features

- $V_{ds} = -30V$
- $I_d = -2.6A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 130m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 200m\Omega$ ($V_{gs} = -4.5V$)

Maximum absolute ratings

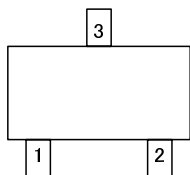
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	V_{ds}	-30	V		
Gate-source voltage	V_{gs}	± 20	V		
Continuous drain current	I_d	$T_a = 25^\circ C$	-2.6	A	1
		$T_a = 70^\circ C$	-2.2		
Pulsed drain current	I_{dm}	-20	A	2	
Power dissipation	P_d	$T_a = 25^\circ C$	1.4	W	1
		$T_a = 70^\circ C$	1.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	$^\circ C$		

Thermal characteristics

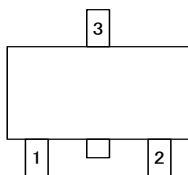
Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	70	90	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		100	125	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	63	80	$^\circ C/W$	3

Pin configuration

SOT-23 (TOP VIEW)



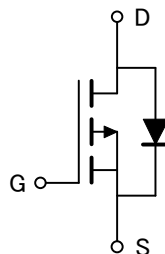
(Without extra bar)



(With extra bar)

Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

Circuit



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Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BV _{dss}	I _d =-250 μA, V _{gs} =0V	-30			V
Zero gate voltage drain current	I _{dss}	V _{ds} =-24V			-1	μA
		V _{gs} =0V		T _j =55°C	-5	
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±100	nA
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250 μA	-1.4	-1.9	-3.0	V
On state drain current	I _{d(on)}	V _{gs} =-4.5V, V _{ds} =-5V	-5			A
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V		97	130	mΩ
		I _d =-2.6A		135	150	
		V _{gs} =-4.5V, I _d =-2A		166	200	mΩ
Forward transconductance	G _{fs}	V _{ds} =-5V, I _d =-2.5A	3.0	3.8		S
Diode forward voltage	V _{sd}	I _s =-1A, V _{gs} =0V		-0.82	-1.00	V
Max. body-diode continuous current	I _s				-2	A
DYNAMIC PARAMETERS						
Input capacitance	C _{iss}			302.0	370.0	pF
Output capacitance	C _{oss}	V _{gs} =0V, V _{ds} =-15V, f=1MHz		50.3		pF
Reverse transfer capacitance	C _{rss}			37.8		pF
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz		12	18	Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Q _g			6.80	9.00	nC
Total gate charge (4.5V)	Q _g	V _{gs} =-10V, V _{ds} =-15V		2.40		nC
Gate-source charge	Q _{gs}	I _d =-2.6A		1.60		nC
Gate-drain charge	Q _{gd}			0.95		nC
Turn-on delay time	t _{d(on)}			7.5		ns
Turn-on rise time	t _r	V _{gs} =-10V, V _{ds} =-15V		3.2		ns
Turn-off delay time	t _{d(off)}	R _l =5.8 Ω, R _{gen} =3 Ω		17.0		ns
Turn-off fall time	t _f			6.8		ns
Body diode reverse recovery time	t _{rr}			16.8	22.0	ns
Body diode reverse recovery charge	Q _{rr}	I _f =-2.6A, dl/dt=100A/μs		10.0		nC

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

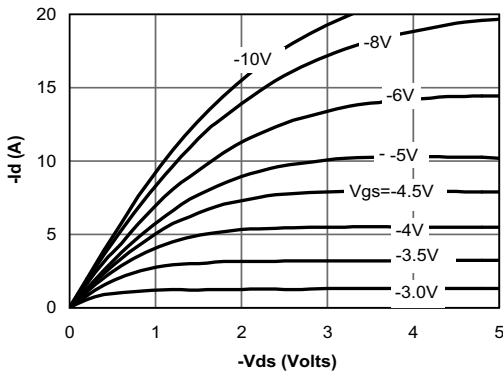


Figure 1: On-Region Characteristics

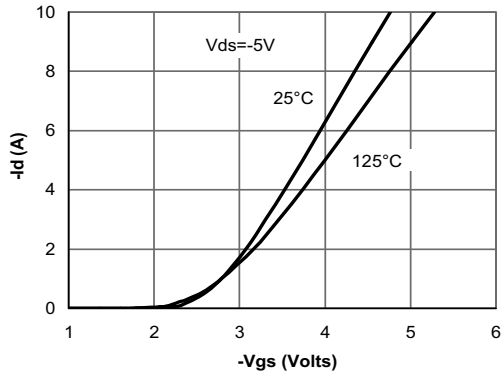


Figure 2: Transfer Characteristics

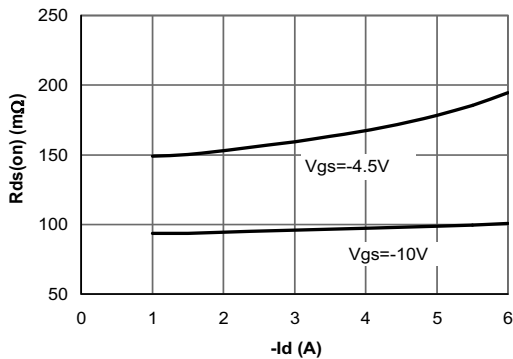


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

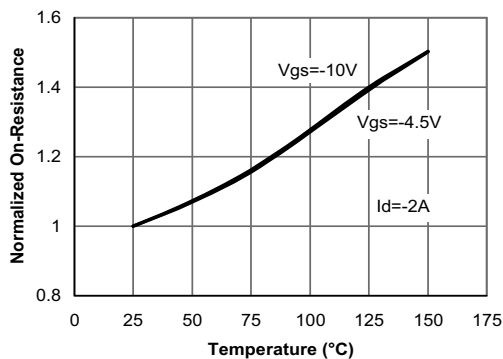


Figure 4: On-Resistance vs. Junction Temperature

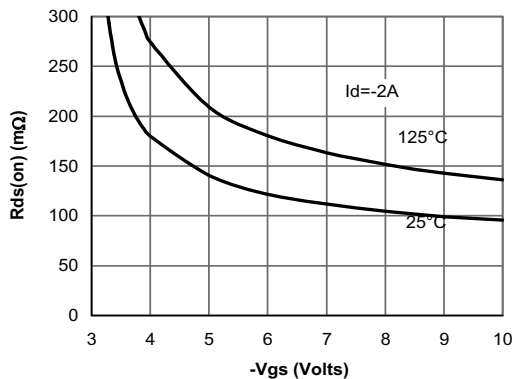


Figure 5: On-Resistance vs. Gate-Source Voltage

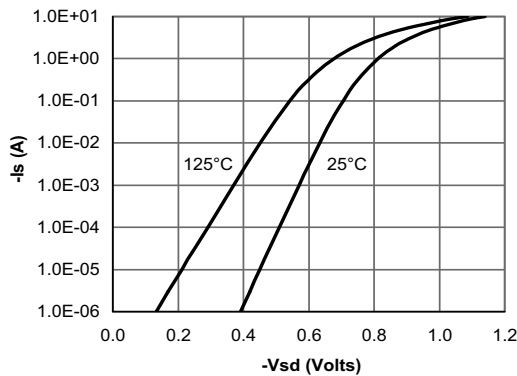


Figure 6: Body-Diode Characteristics

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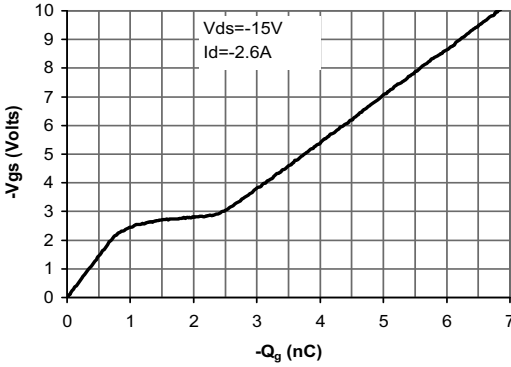


Figure 7: Gate-Charge Characteristics

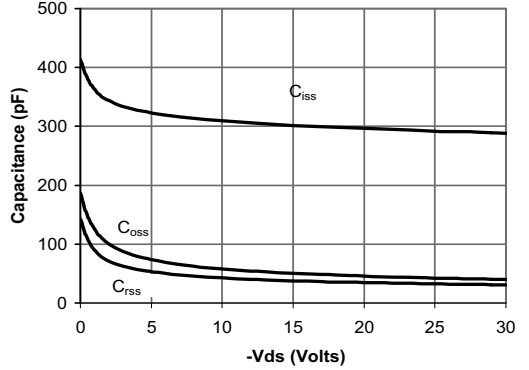


Figure 8: Capacitance Characteristics

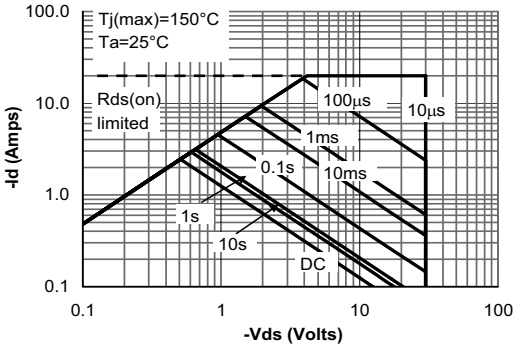


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

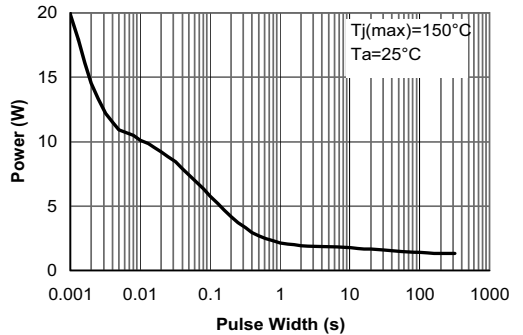


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

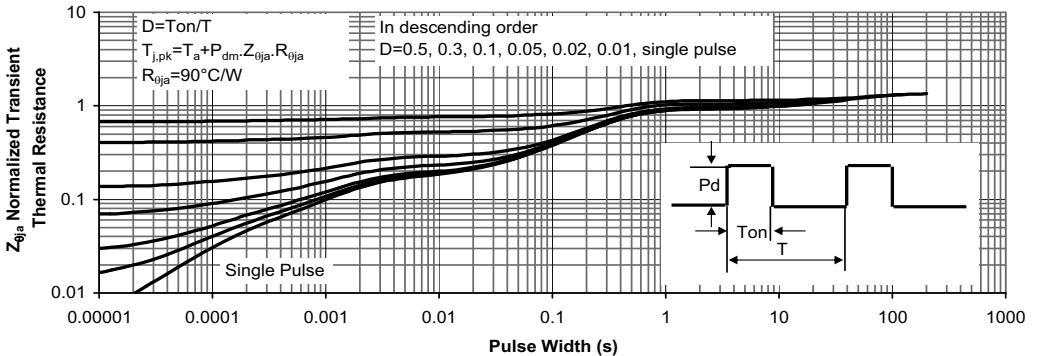


Figure 11: Normalized Maximum Transient Thermal Impedance